

SID

Factory: Rot am See

Article:

ML8

Provided:

Customer:

Date:

03.04.2026

WÜRTH
ELEKTRONIK
MORE THAN
YOU EXPECT

Processtechnology: B: undefined

Material Text	Mat. Nr.	µm	Stackup	Process overview
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A-RS Kupferfolie-018my 330x490mm	50200238	18	VS	1	
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	146		2	
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		3	
		18	L2		
A-RS-FR4-ML-0.508mm-018+018-TG150-HF-...	50203031	508		4	A01
		18	L3		
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	185		5	
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		6	
		18	L4		
A-RS-FR4-ML-0.508mm-018+018-TG150-HF-...	50203031	508		7	A02
		18	L5		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	185		8	
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	0		9	
		18	L6		
A-RS-FR4-ML-0.508mm-018+018-TG150-HF-...	50203031	508		10	A03
		18	L7		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	146		11	
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		12	
A-RS Kupferfolie-018my 330x490mm	50200238	18	RS	13	

Thickness after Pressing

B00:

2290 µm

Tol+:

240 µm

Tol-:

240 µm

Dmax:

2530 µm

Dmin:

2050 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

2400 µm

Tol+:

240 µm

Tol-:

240 µm

Dmax:

2640 µm

Dmin:

2160 µm

Measuring point: (05) over SM and galv. Cu; both sides

nominal:

2330 µm

Version 1.2.20.35

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